

N-Ch and P-Channel MOSFET

General Description

The WSF3013B is the highest performance trench N-ch and P-ch MOSFETs with extreme high cell density, which provide excellent RDSON and gate charge for most of the synchronous buck converter applications.

The WSF3013B meet the RoHS and Green Product requirement 100% EAS guaranteed with full function reliability approved.

Features

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent CdV/dt effect decline
- 100% EAS Guaranteed
- Green Device Available

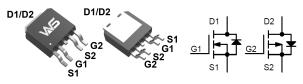
Product Summery

BVDSS	RDSON	ID
30V	15mΩ	22A
-30V	25mΩ	-19A

Applications

- High Frequency Point-of-Load Synchronous Buck Converter for MB/NB/UMPC/VGA
- Networking DC-DC Power System
- CCFL Back-light Inverter

TO-252-4L Pin Configuration



		Rati		
Symbol	Parameter	N-Ch	P-Ch	Units
V _{DS}	Drain-Source Voltage	30	-30	V
V _{GS}	Gate-Source Voltage	±20	±20	V
ID	Continuous Drain Current, V _{GS(NP)} =10V,T _c =25 [°] C	22	-19	А
	Continuous Drain Current, V _{GS(NP)} =10V,T _c =100 [°] C	10	-8	А
I _{DP} ^a	Pulse Drain Current Tested, V _{GS(NP)} =10V	52	-45	A
E _{AS} ^c	Avalanche Energy, Single pulse , L=0.5mH	22	45	mJ
I _{AS} ^c	Avalanche Current, Single pulse, L=0.5mH	21	-30	А
PD	Total Power Dissipation, T _c =25 [°] C	18	18	W
T _{STG}	Storage Temperature Range	-55 to 150	-55 to 150	°C
TJ	Operating Junction Temperature Range	150	150	°C
R _{0JA} ^b	Thermal Resistance-Junction to Ambient, Steady State	62	62	°C/W
R _{θJC}	Thermal Resistance-Junction to Case, Steady State	5.0	5.0	°C/W

Note * : Max. current is limited by bonding wire.

Note a : Pulse width limited by max. junction temperature.

Note b : $R_{\theta JA}$ steady state t=999s. $R_{\theta JA}$ is measured with the device mounted on 1in², FR-4 board with 2oz. Copper.

Note c : UIS tested and pulse width limited by maximum junction temperature 150° C (initial temperature $T_i=25^{\circ}$ C).

Absolute Maximum Ratings



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N-Electrical Characteristics (T_J=25⁻¹C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	30			V
b a	Static Drain-Source On-Resistance	V _{GS} =10V , I _D =10A		15	22	mΩ
R _{DS(ON)} ^d	Static Drain-Source On-Resistance	V _{GS} =4.5V , I _D =5A		20	30	
V _{GS(th)}	Gate Threshold Voltage	V_{GS} = V_{DS} , I_D =250 uA	1.0	1.6	2.5	V
I	Drain-Source Leakage Current	V_{DS} =20V , V_{GS} =0V , T_J =25 $^\circ$ C			1	uA
I _{DSS}		V_{DS} =20V , V_{GS} =0V , T_{J} =85 $^{\circ}$ C			30	
I _{GSS}	Gate-Source Leakage Current	V_{GS} = $\pm20V$, V_{DS} =0V			±100	nA
R _g	Gate Resistance	V_{DS} =0V , V_{GS} =0V , f=1MHz		2.5	5.0	Ω
Qg ^e	Total Gate Charge	V _{DS} =20V, V _{GS} =4.5V, I _{DS} =10A		7.2		
Qgs ^e	Gate-Source Charge			1.4		nC
Q _{gd} e	Gate-Drain Charge			2.2		
T _{d(on)} e	Turn-On Delay Time	$ V_{DD}=15V, \\ I_{DS}=5A, V_{GS}=10V, \\ R_{G}=3.3R. $		4.1		
Tre	Rise Time			9.8		20
T _{d(off)} e	Turn-Off Delay Time			15.5		ns
T _f e	Fall Time			6.0		
C _{iss} e	Input Capacitance	V _{DS} =15V , V _{GS} =0V , f=1MHz		572		
C _{oss} ^e	Output Capacitance			81		pF
Crss ^e	Reverse Transfer Capacitance			65		

Diode Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Continuous Source Current	$V_G=V_D=0V$, Force Current			10	А
V _{SD} ^d	Diode Forward Voltage	V _{GS} =0V , I _S =1A , T _J =25℃			1.2	V

Note d : Pulse test ; pulse width ${\leq}300\mu\text{s},$ duty cycle ${\leq}2\%.$

Note e : Guaranteed by design, not subject to production testing.



N-Ch and P-Channel MOSFET

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V_{GS} =0V , I _D =-250uA	-30			V
D d	Static Drain-Source On-Resistance	V _{GS} =-10V , I _D =-7A		25	33	
R _{DS(ON)} ^d		V _{GS} =-4.5V , I _D =-5A		37	54	mΩ
V _{GS(th)}	Gate Threshold Voltage	$V_{GS}=V_{DS}$, $I_{D}=-250$ uA	-1.0		-2.8	V
I _{DSS}	Drain-Source Leakage Current	$V_{\text{DS}}\text{=-20V}$, $V_{\text{GS}}\text{=}0\text{V}$, $T_{\text{J}}\text{=}25^\circ\!\!\mathrm{C}$			-1	- uA
IDSS		V_{DS} =-20V , V_{GS} =0V , T_{J} =85 $^{\circ}$ C			-30	
I _{GSS}	Gate-Source Leakage Current	$V_{GS}=\pm20V$, $V_{DS}=0V$			±100	nA
Qg ^e	Total Gate Charge			9.8		
Q _{gs} e	Gate-Source Charge	V _{DS} =-15V , V _{GS} =-4.5V , I _D =-12A		2.2		nC
Q _{gd} e	Gate-Drain Charge			3.4		
T _{d(on)} e	Turn-On Delay Time			16.4		
Tr ^e	Rise Time	V_{DD} =-15V , V_{GS} =-10V , R_G =6 Ω ,		20.2		20
T _{d(off)} e	Turn-Off Delay Time	I _D =-1A ,R _L =15Ω,		55		ns
T _f e	Fall Time			10		
C _{iss} e	Input Capacitance			930		
C _{oss} e	Output Capacitance	V _{DS} =-15V , V _{GS} =0V , f=1MHz		148		pF
C _{rss} ^e	Reverse Transfer Capacitance			115		

P-Channel Electrical Characteristics (T_J=25 $^{\circ}$ C, unless otherwise noted)

Diode Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
I _S	Continuous Source Current	$V_G = V_D = 0V$, Force Current			-8	А
V _{SD} ^e	Diode Forward Voltage	V _{GS} =0V , I _S =-1A , T _J =25℃			-1.2	V

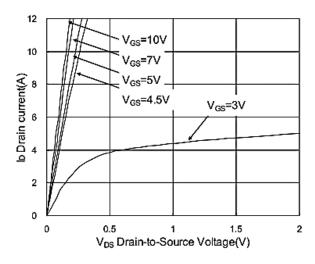
Note d : Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2%.

Note e : Guaranteed by design, not subject to production testing.



N-Ch and P-Channel MOSFET

N-Channel Typical Characteristics





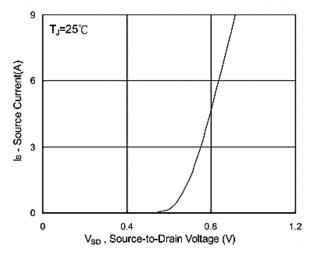


Fig.3 Forward Characteristics Of Reverse

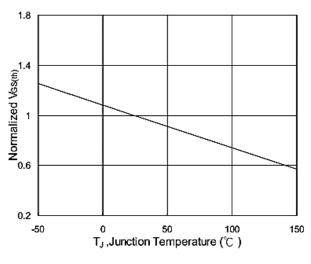


Fig.5 Normalized V_{GS(th)} v.s T_J

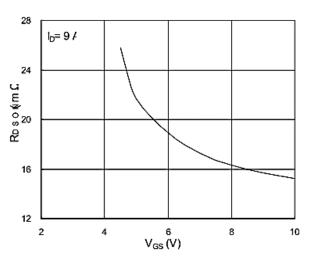


Fig.2 On-Resistance v.s Gate-Source

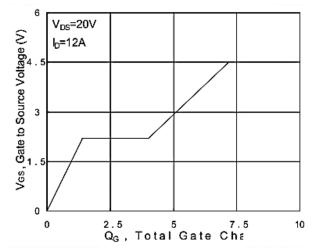


Fig.4 Gate-Charge characteristics

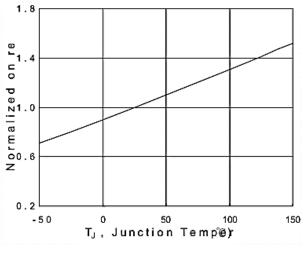


Fig.6 Normalized RDSON v.s TJ



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N-Channel Typical Characteristics

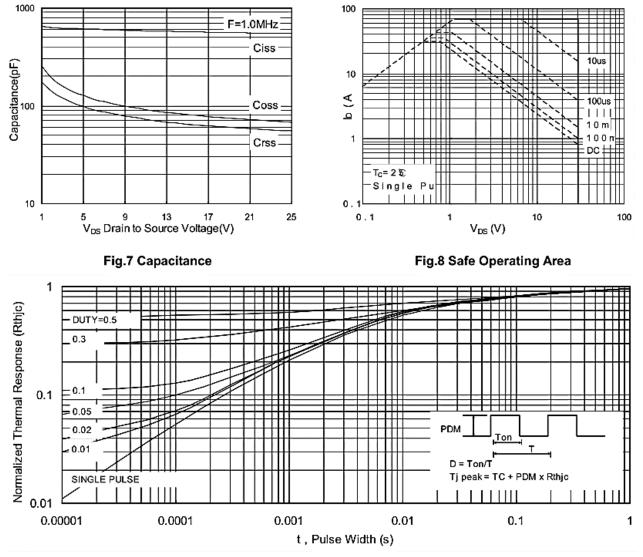
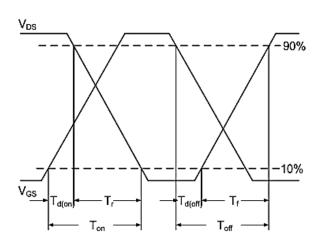
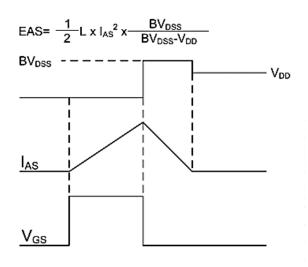


Fig.9 Normalized Maximum Transient Thermal Impedance





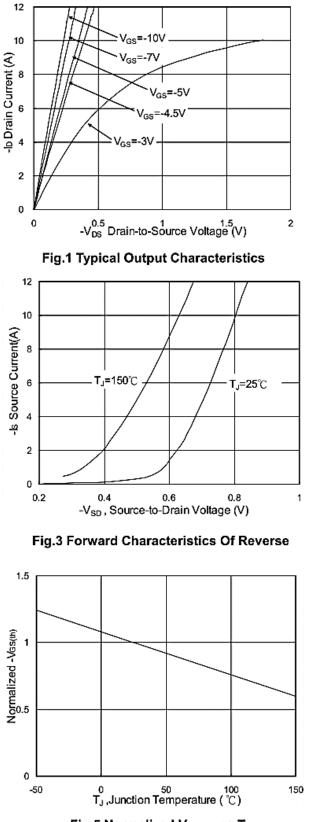


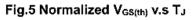


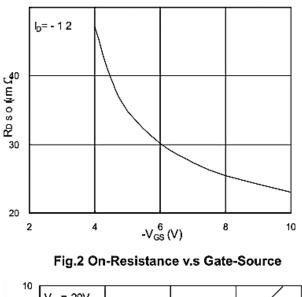


N-Ch and P-Channel MOSFET

P-Channel Typical Characteristics







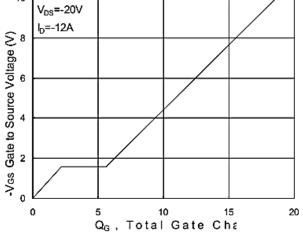
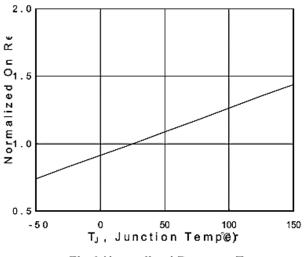
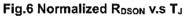


Fig.4 Gate-Charge Characteristics







N-Ch and P-Channel MOSFET

P-Channel Typical Characteristics

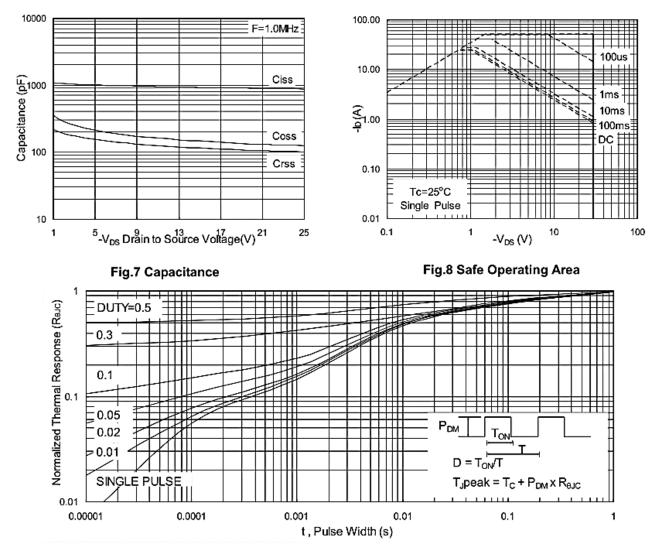


Fig.9 Normalized Maximum Transient Thermal Impedance

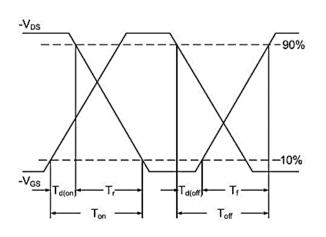
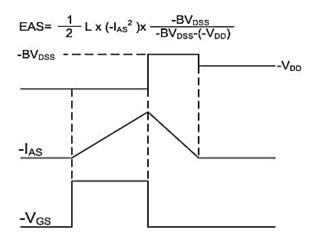


Fig.10 Switching Time Waveform







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